

Standard Diagnostics for SwissFEL

Rasmus Ischebeck, for the GFA Diagnostics Section

Standard Diagnostics for SwissFEL



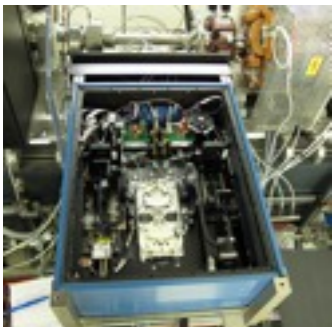
> Transverse profile imager (DSCR)



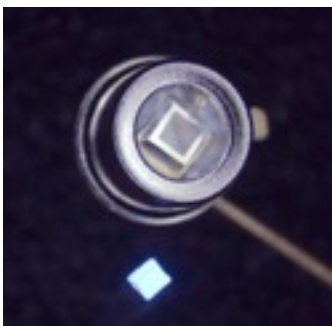
> Synchrotron radiation imager (DSRM)



> Electron Beam position monitor (DBPM)

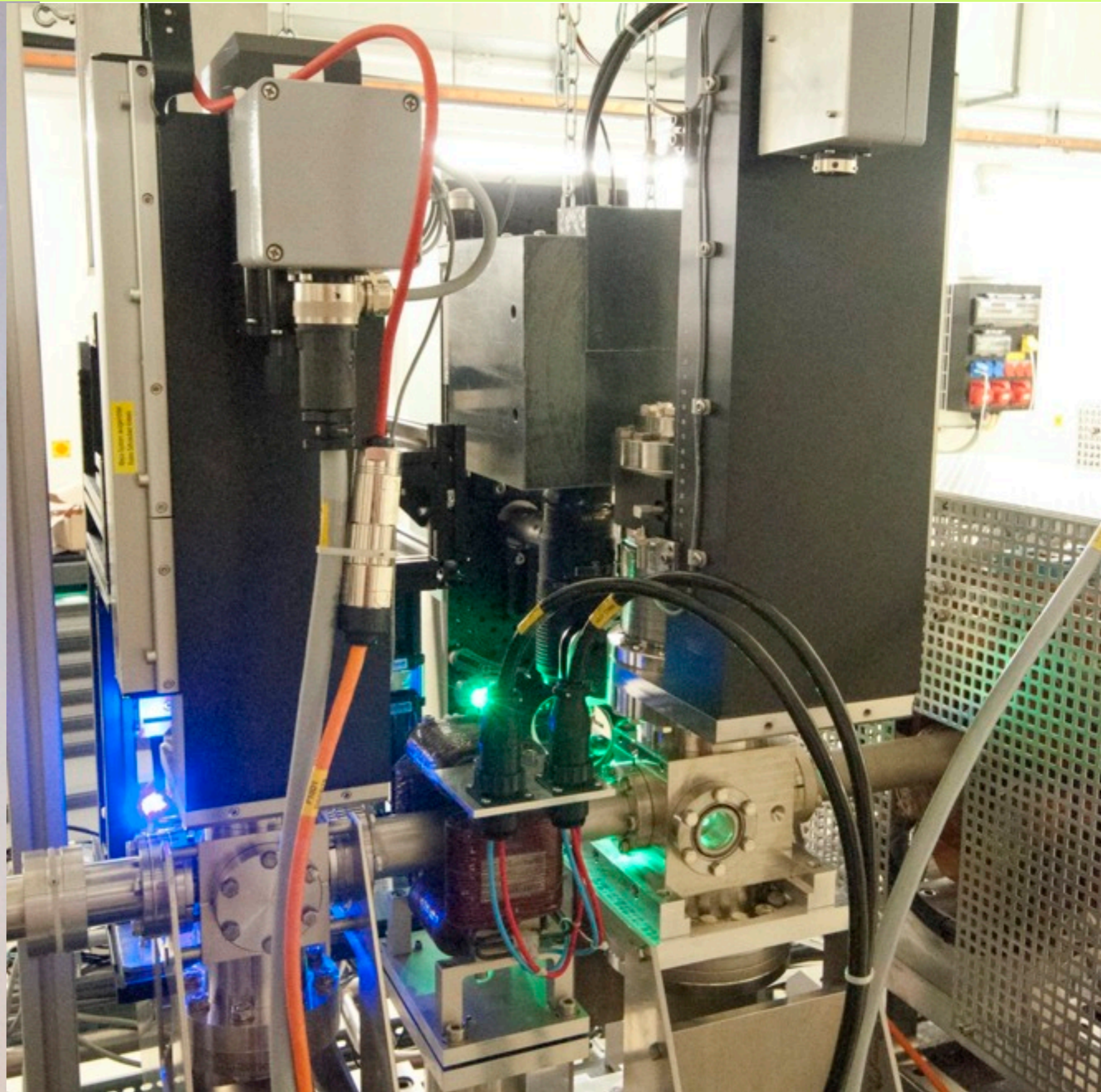
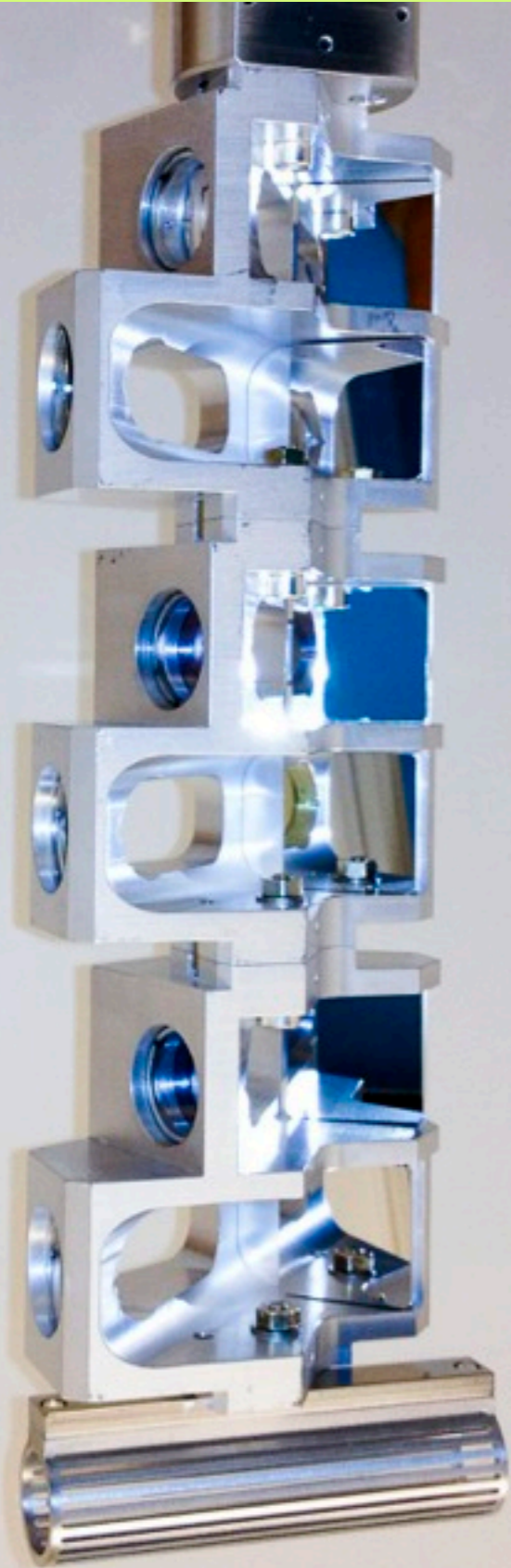


> Electron bunch arrival monitor (DBAM)



> Loss monitor (DBLM)

Transverse Profile Imager (DSCR)



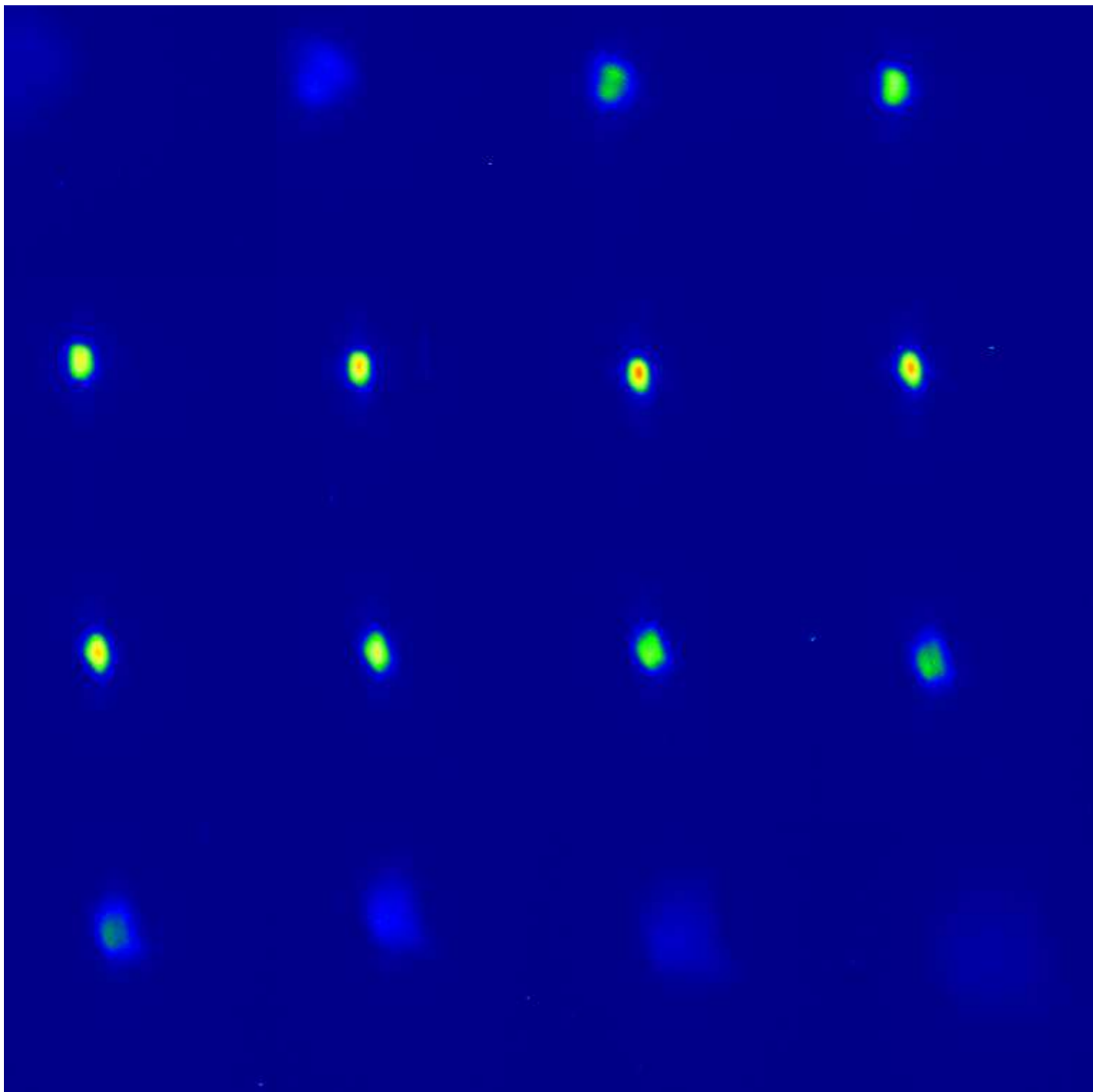
Transverse Profile Imager (DSCR)

> Specifications

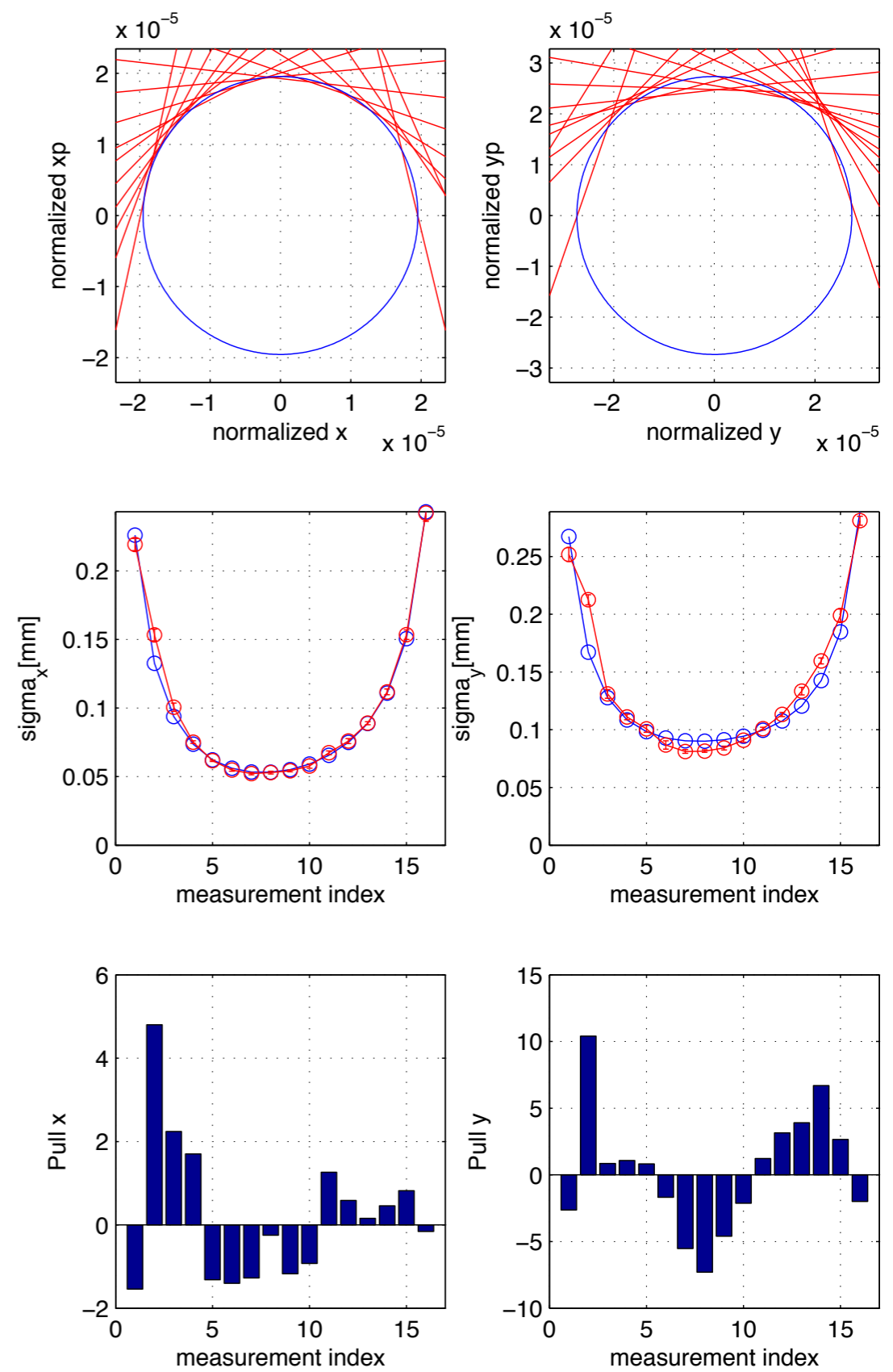
Quantity	“Overview”	“Measurement”
Resolution	10 μm	
Field of view	6 mm (h) \times 8 mm (v)	6 mm (h) \times 15 mm (v)
Sensitivity	ionizing radiation	
Image frame rate	10 Hz	100 Hz
Length of vacuum chamber	137 mm	
Required space outside of vacuum chamber	tbd.	

Transverse Profile Imager (DSCR)

> Emittance Measurement

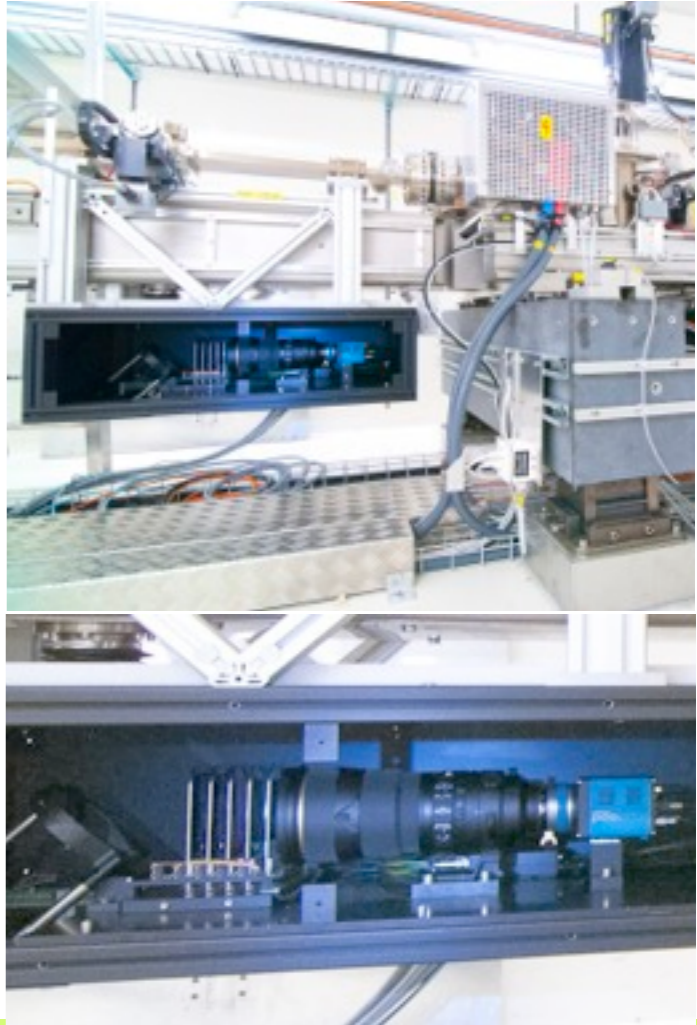
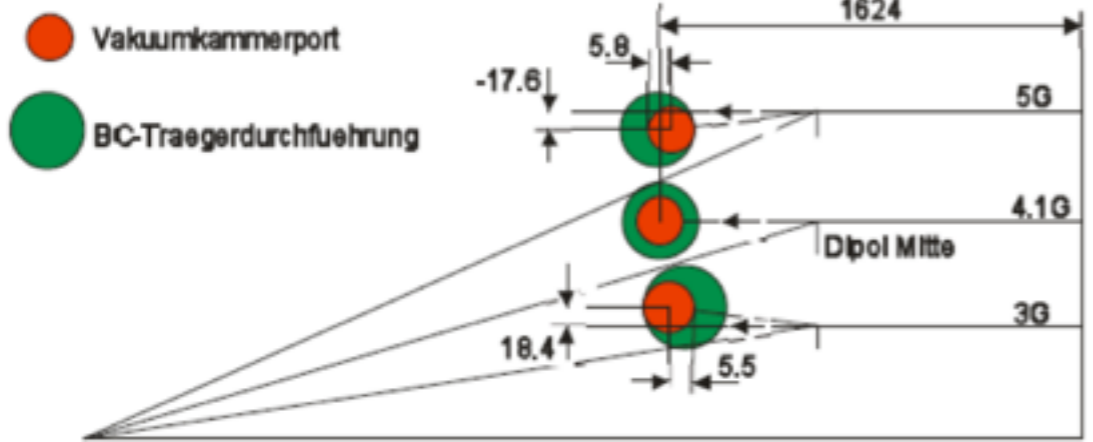
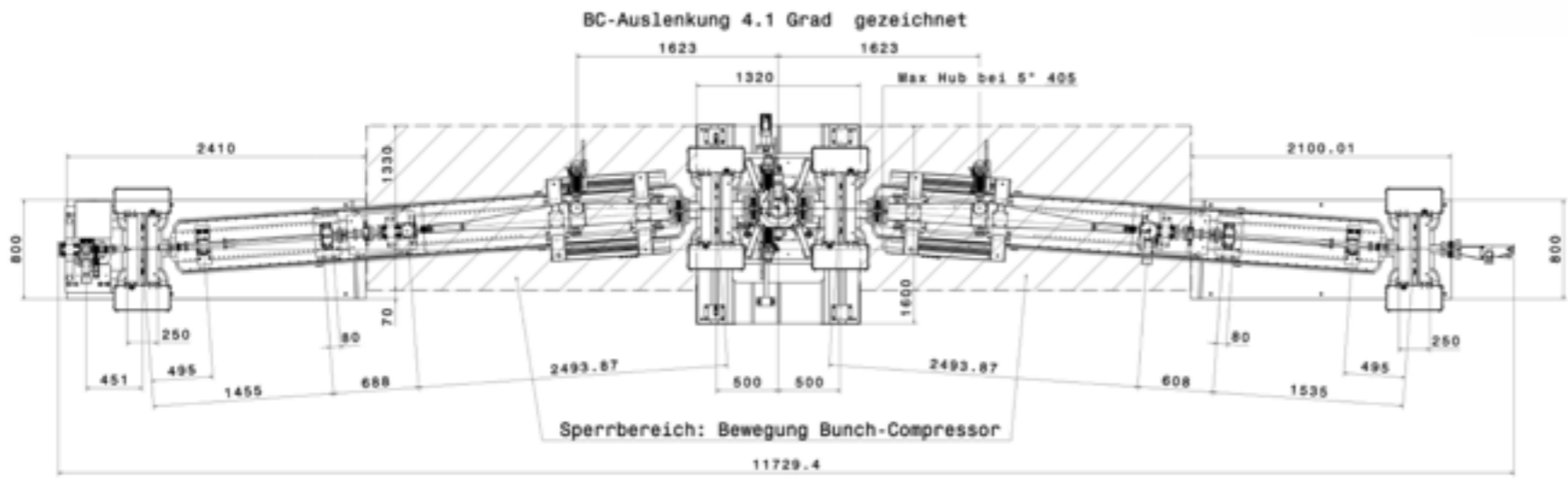
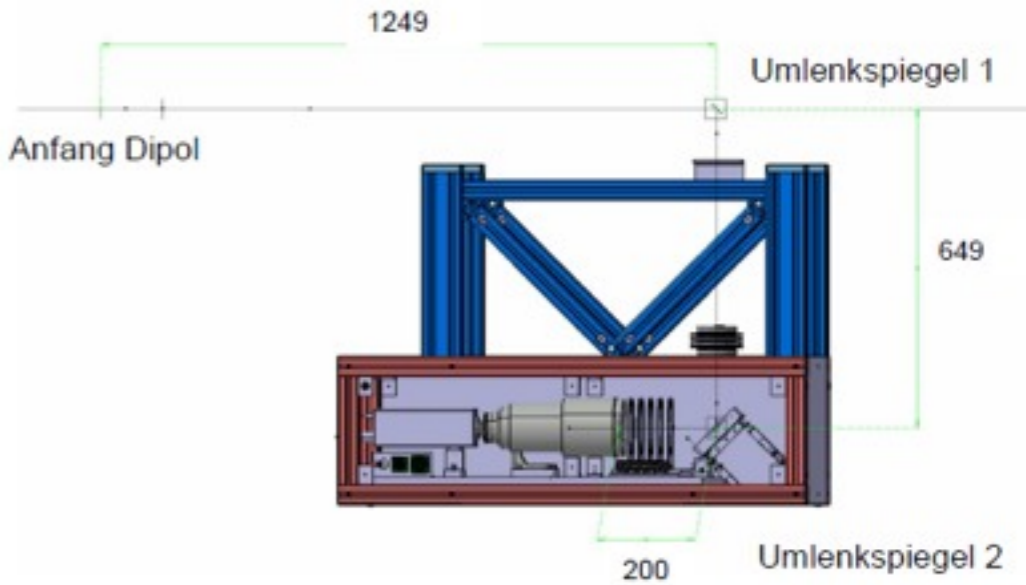
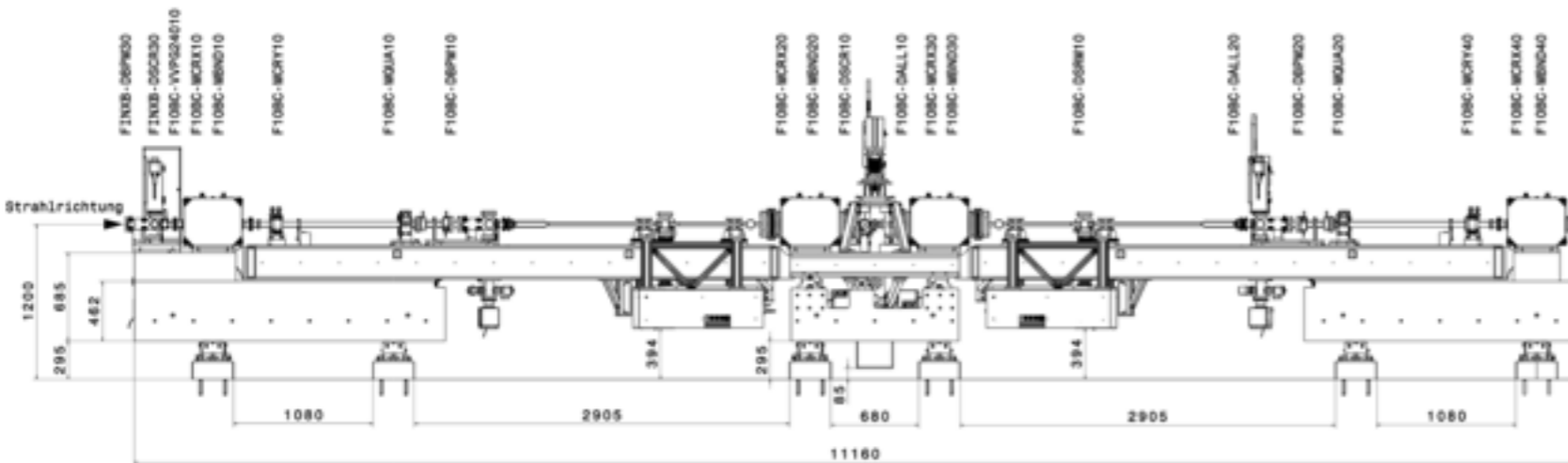


The smallest beam in this measurement is 50 μm rms. Beams of 10 μm rms have been measured.



Synchrotron Radiation Imager (DSRM)

Technical Realization-BC 250 MeV Injector Test Facility



Technical drawings, courtesy L. Schulz, P. Heimgartner

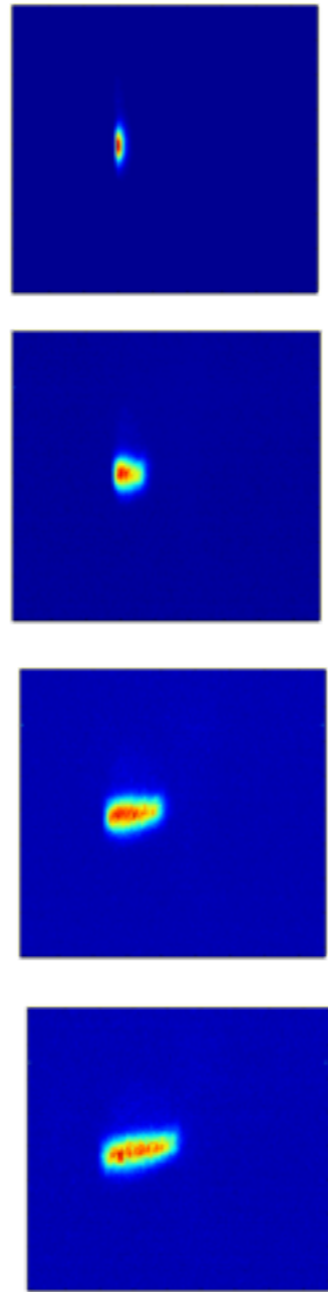
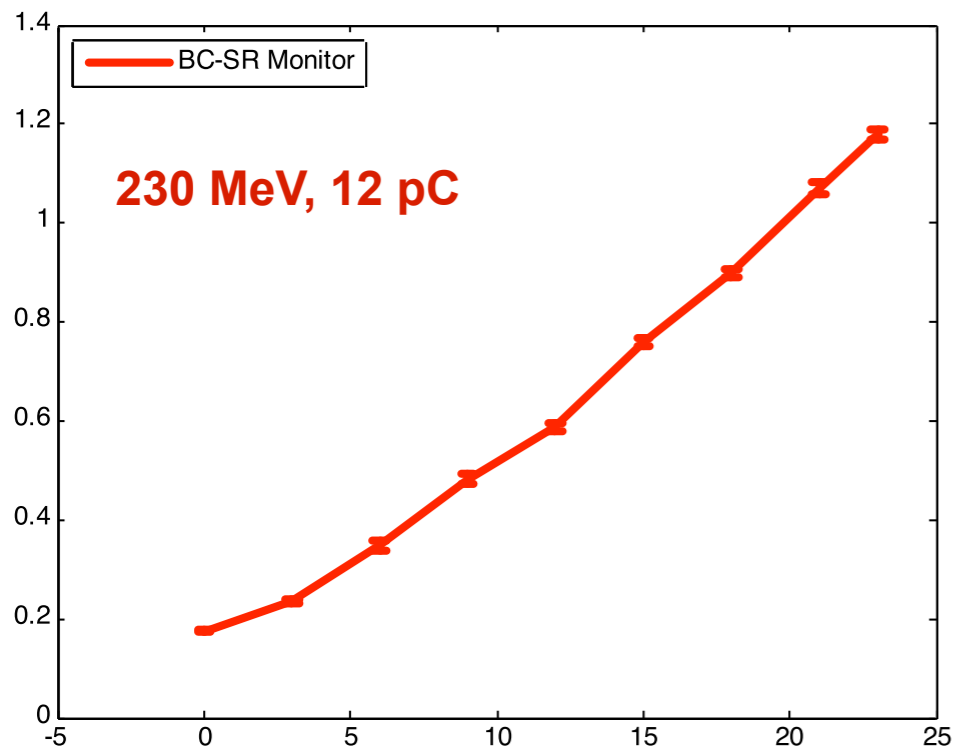
Synchrotron Radiation Imager (DSRM)

Conceptual Design-BC SwissFEL

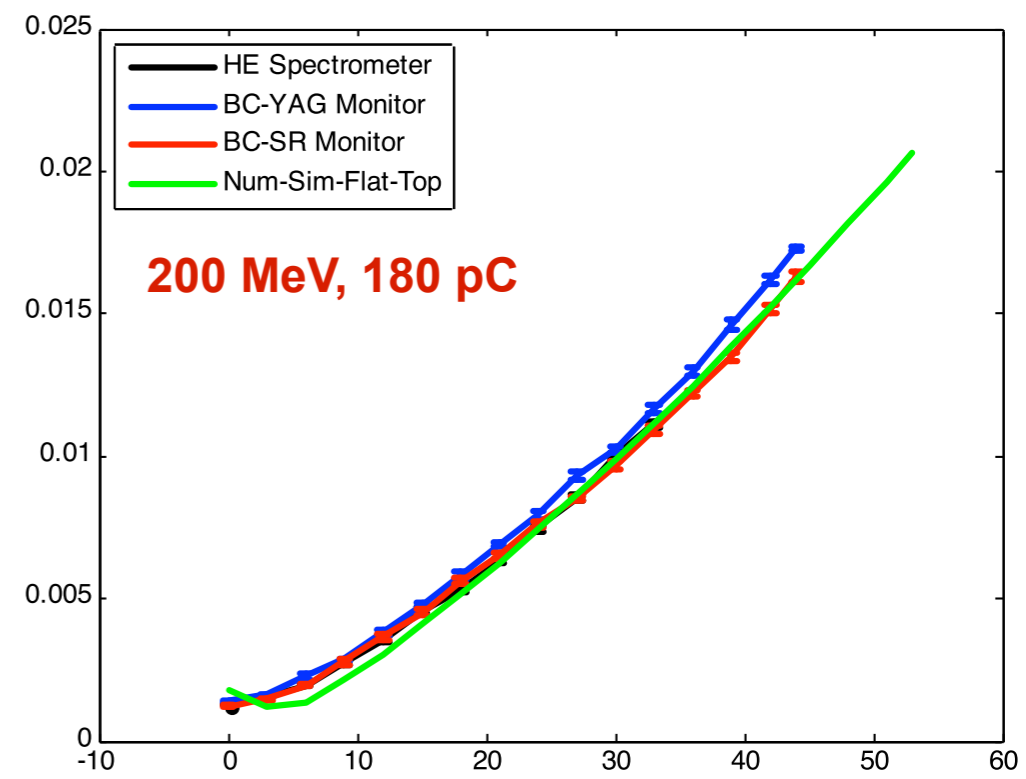
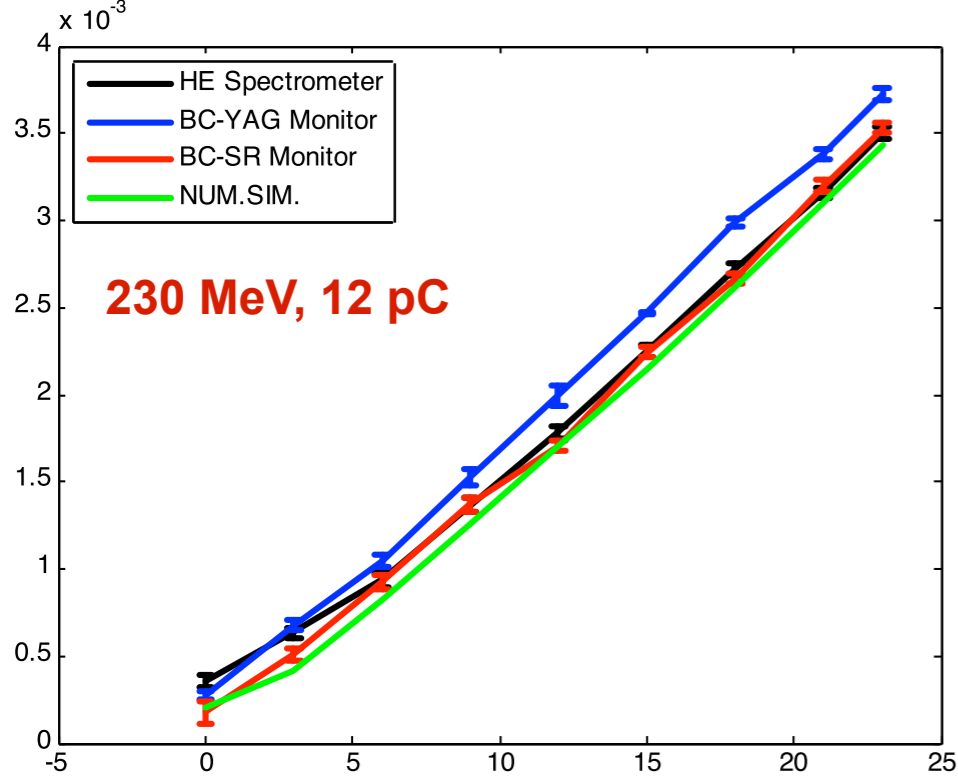
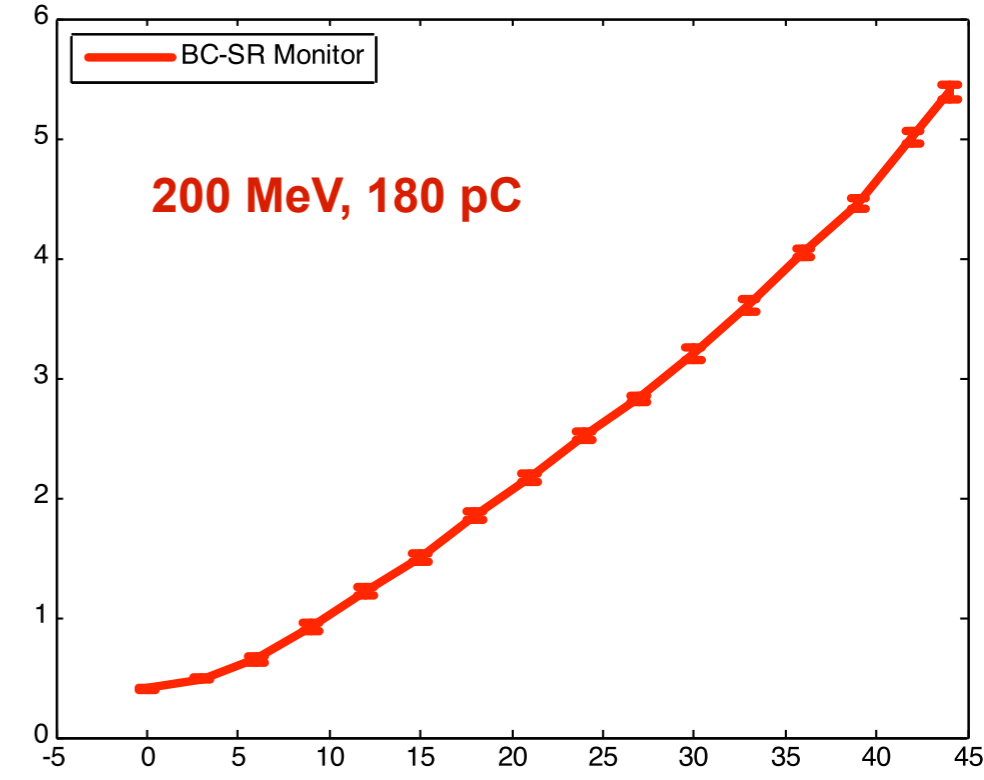
	BC1	BC2
Nominal bending angle θ	3.85 deg	2.15
Mechanical bending angle range	-0.1 \leftrightarrow 4.6 deg	-0.1 \leftrightarrow 3.8 deg
Operational bending angle	2.85 \leftrightarrow 4.6 deg	1.15 \leftrightarrow 3.15 deg
Horizontal Dispersion	419.6 mm	281.56
Nominal Beam Energy	350 MeV	2100 MeV
Range for transverse movement	-10 \leftrightarrow 500 mm	-10 \leftrightarrow 495 mm
Beam Size (rms) at the 3 rd dipole	6.0 mm	1.2 mm
Field of View (in-vacuum mirror length=68 mm)	68 mm	68 mm
Projected pixel size	31 μm	38 μm
Relative Energy Spread Resolution	$7.0 \cdot 10^{-5}$	$1.4 \cdot 10^{-4}$
Lens focal length	400 mm	500 mm
Lens diameter	143 mm	125 mm
Camera (PCO.EDGE) pixel size	6.5x6.5 μm^2	6.5x6.5 μm^2
Camera Resolution	hor x ver = 2560x2160	hor x ver = 2560x2160
Camera Frame Rate	100 Hz	100 Hz
Separation in-vacuum mirror edge and central trajectory of the beam	40 mm	61.5 mm

Synchrotron Radiation Imager (DSRM)

Prototype Results - 250 MeV Injector Test Facility (SITF)



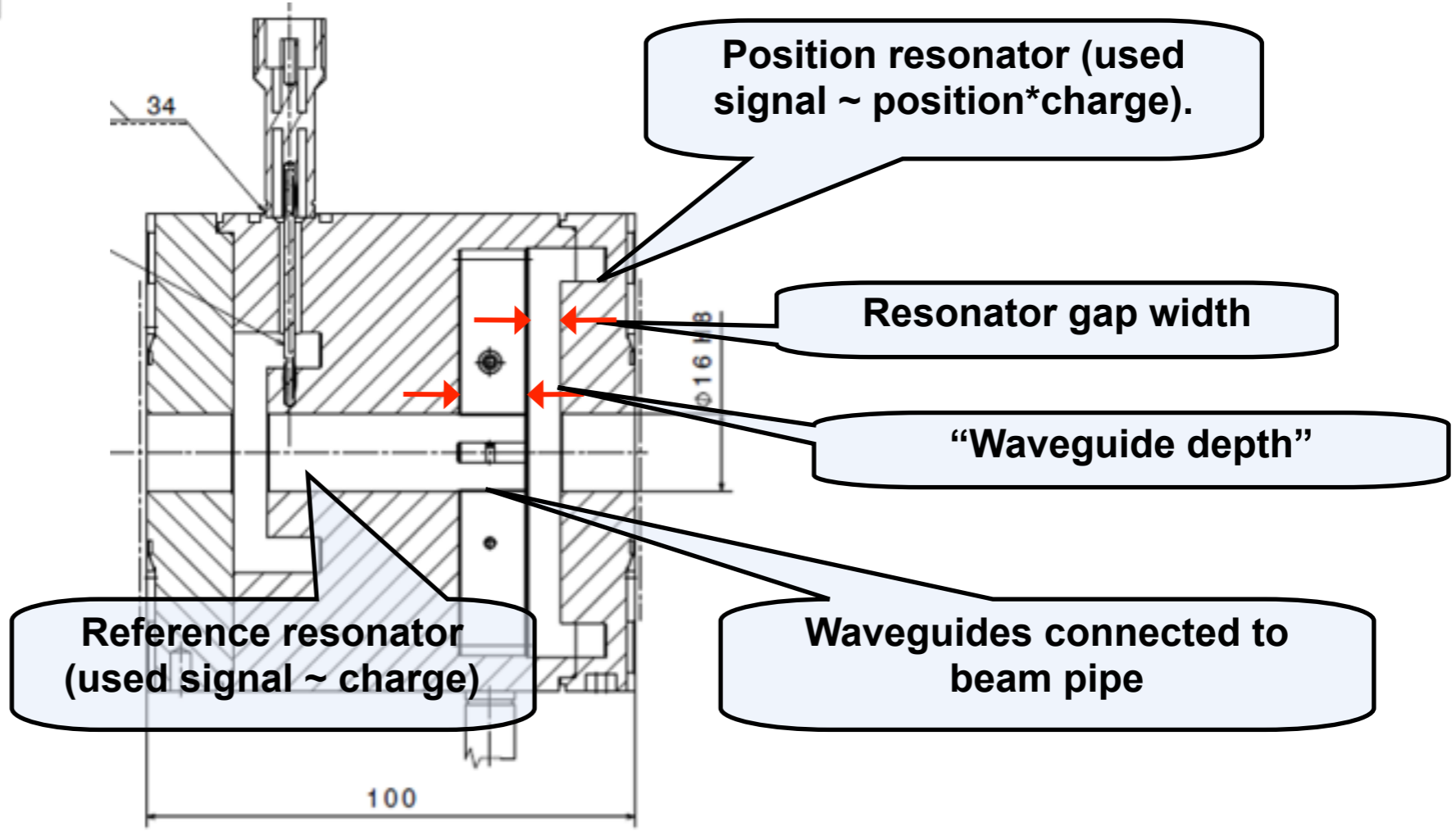
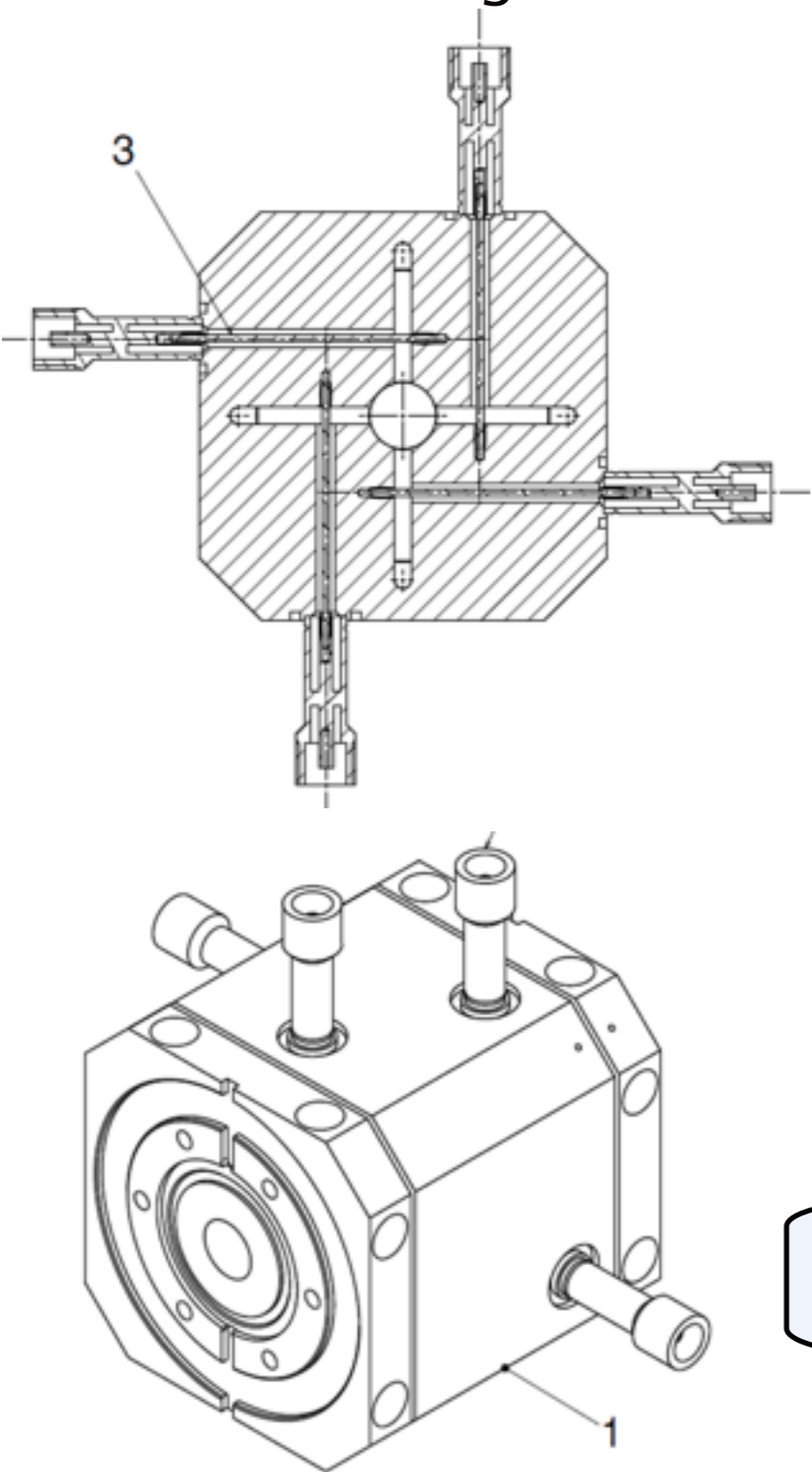
12 pC, SR Monitor images, 0- 23 deg OFF RF Crest



Electron Beam position monitor (DBPM)

> Technical Design: Linac Pickup

- Based on E-XFEL/SACLA design
- Optimized for low charge & low production costs.



Electron Beam position monitor (DBPM)

> Technical Design: Parameters

	Injector	Linac	Undulator (Baseline)	Undulator (Alternative Option)
Pickup Type	Cavity (2 Resonators, Mode-Suppressing Couplers)			
Frequency	3.3GHz			4.8GHz
Loaded Q	~40		~70	~100-1000
Material	Stainless Steel			Cu-Coated Steel
Gap Width	TBD	7mm	7mm	TBD
Waveguide Depth	TBD	14mm	25mm	TBD
Signal [V/mm/nC]	TBD	7.1	9.3***	TBD
RFFE	IQ Downconversion*			
IF Frequency	~0Hz			~50MHz
ADC	16-Bit 160MSPS (Linac/Injector: 12-Bit 500MSPS Option)**			

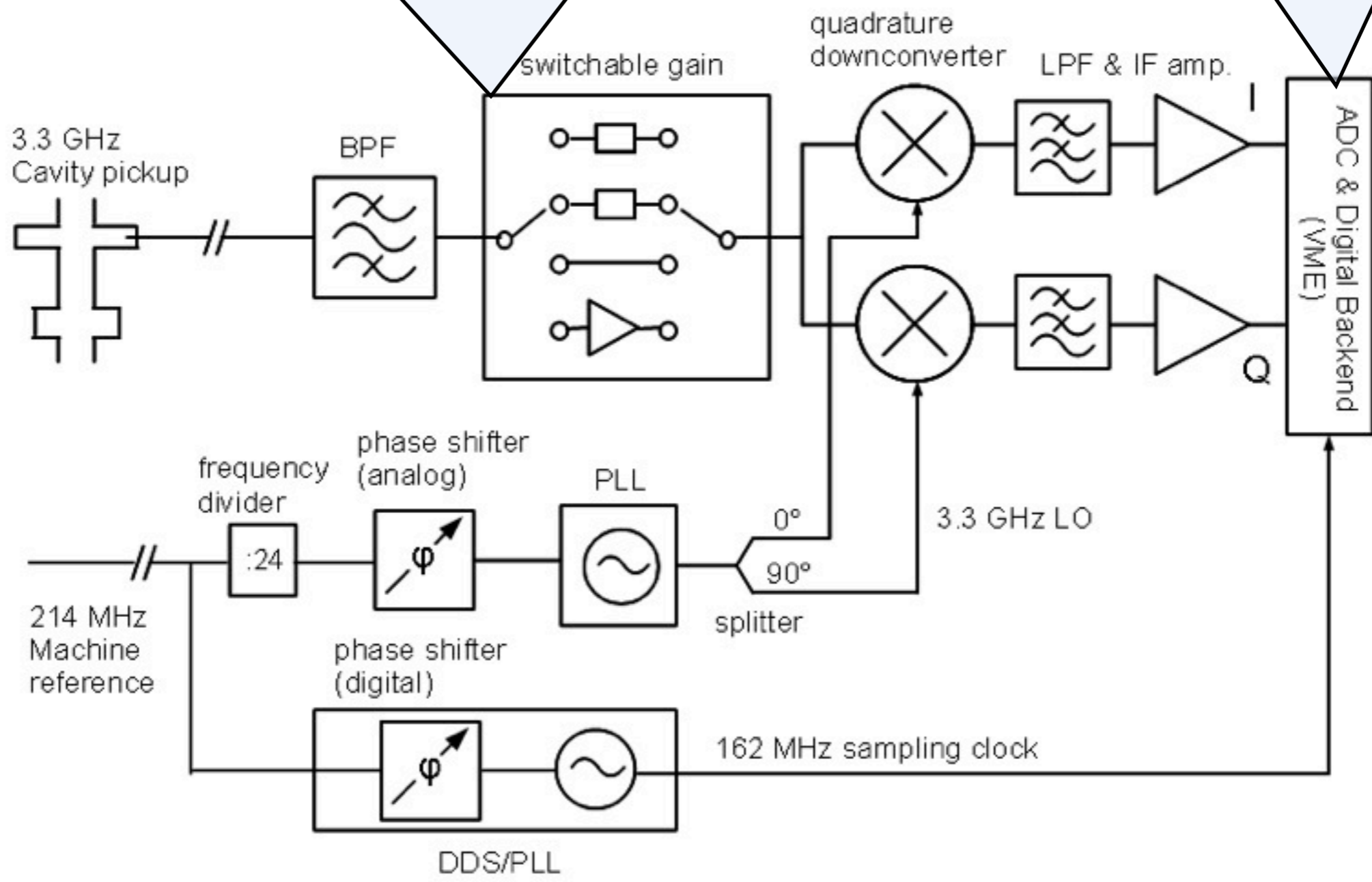
* Undulators (Alternative Option): Single-channel downconversion feasible, to be evaluated.
 ** Sample rates of available ADCs for European XFEL (E-XFEL) BPM electronics built by PSI
 *** E-XFEL Undulator: 2.9 V/mm/nC (Q=70) -> ~3x better low charge resolution for SwissFEL.

Electron Beam position monitor (DBPM)

> Technical Design: RF Front-End

Final version: 63dB, 0.5dB step attenuator. Maximal ADC level for any charge & offset.

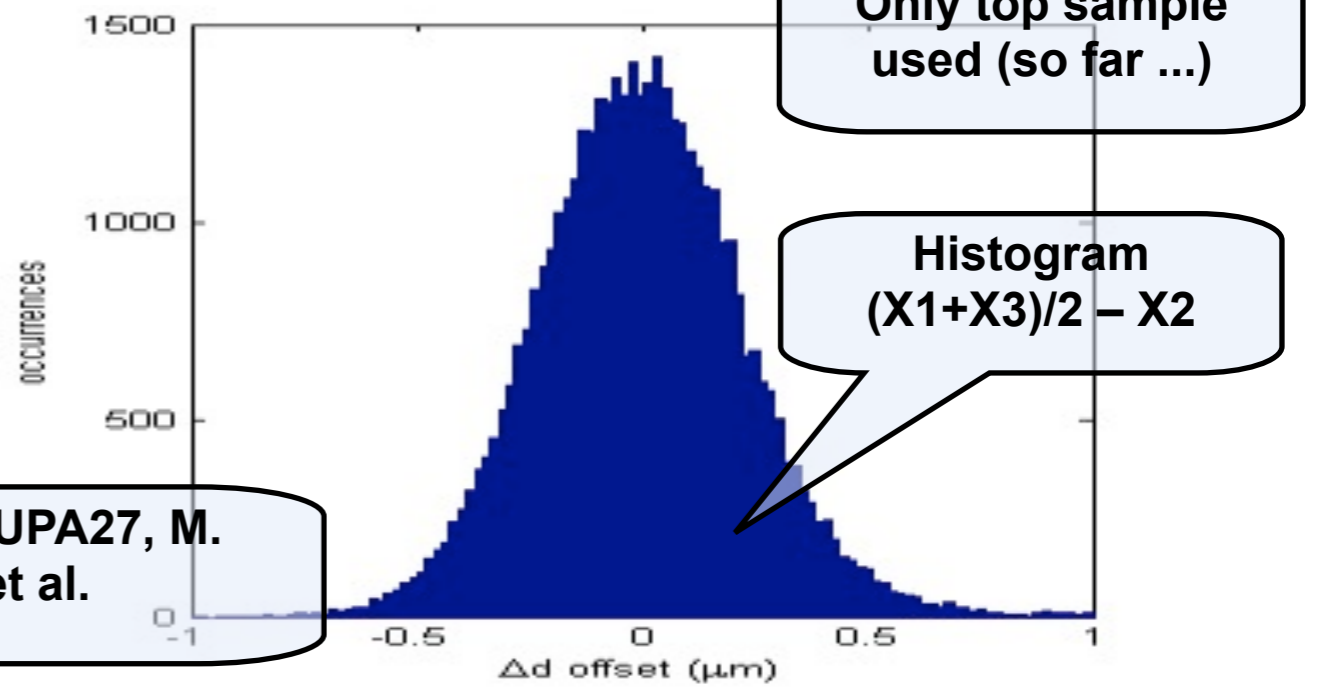
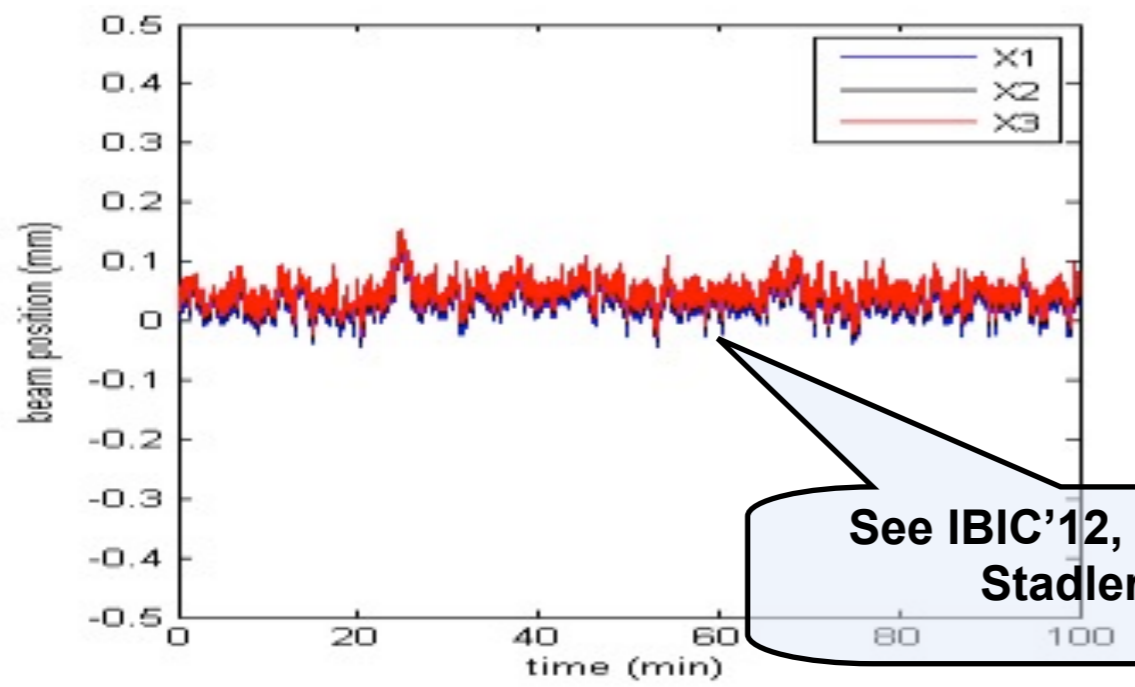
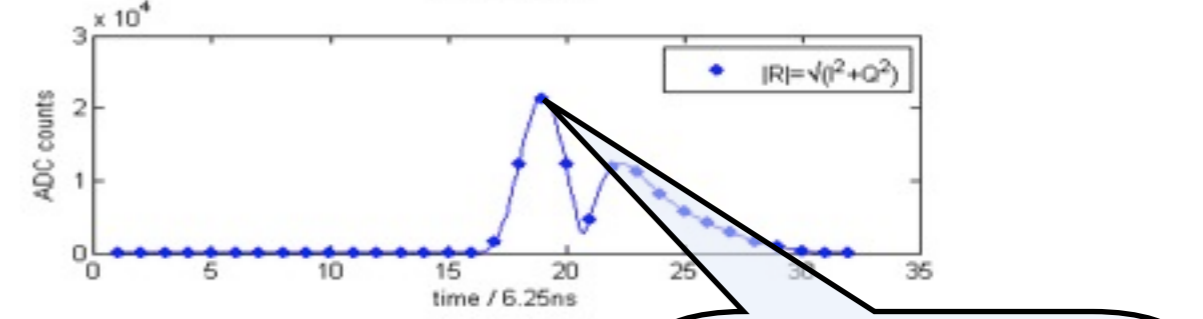
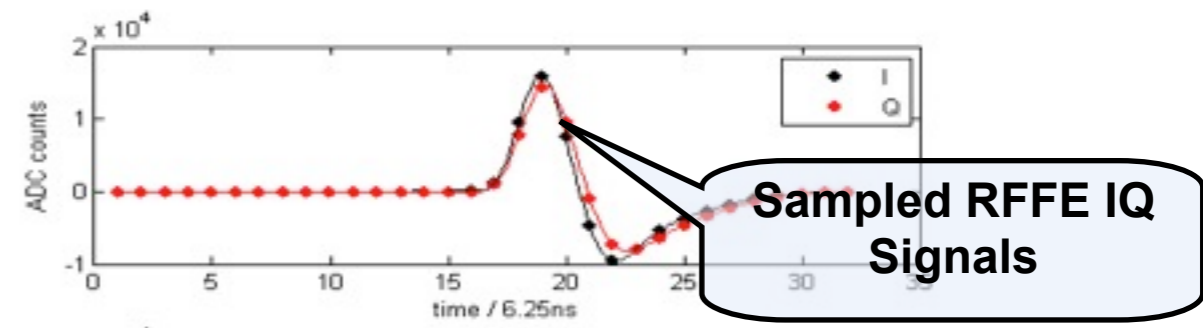
Details: See talk G. Marinkovic et al.



Electron Beam position monitor (DBPM)

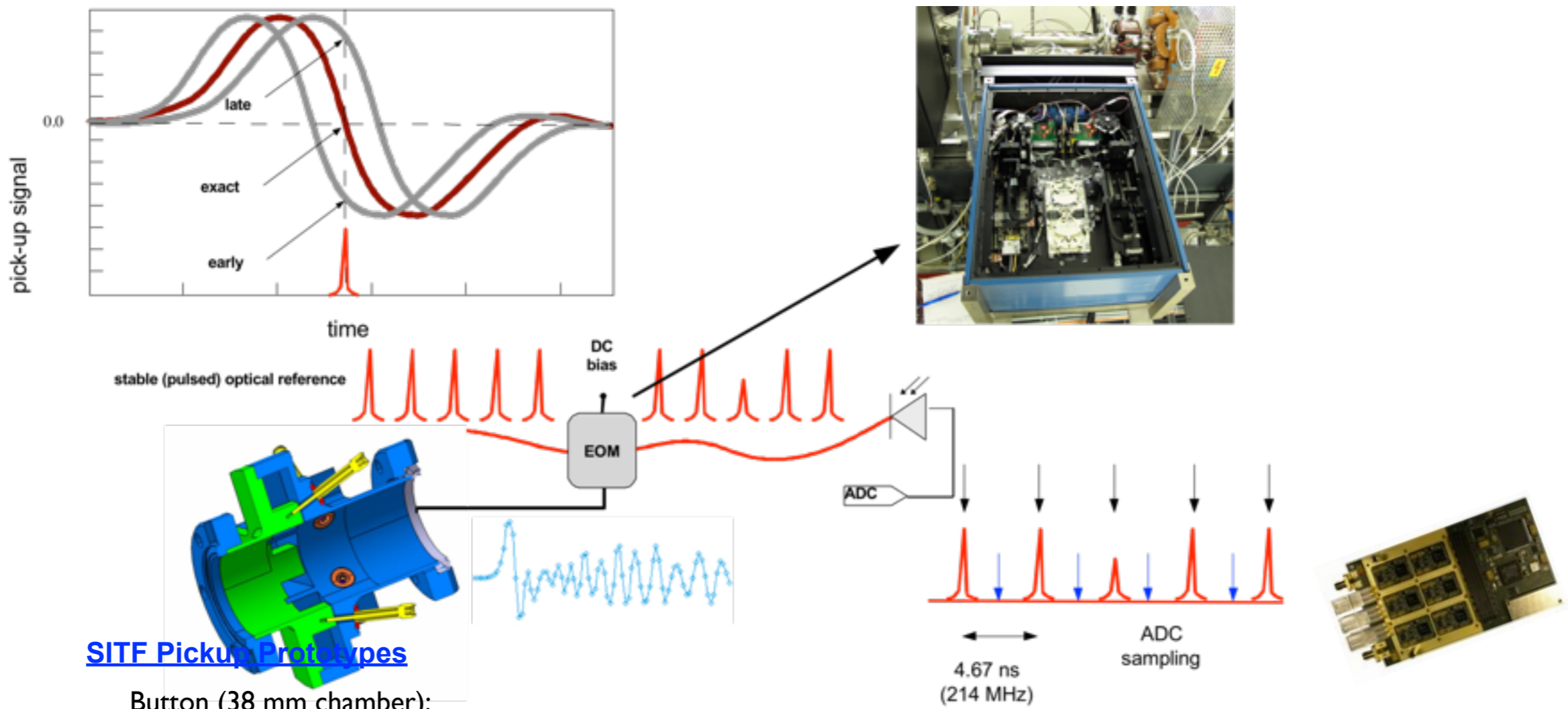
> Results: Prototype Beam Test

Correlation of 3 E-XFEL Undulator Cavity BPMs



Electron bunch arrival monitor (DBAM)

BAM Detection Principle



SITF Pickup Prototypes

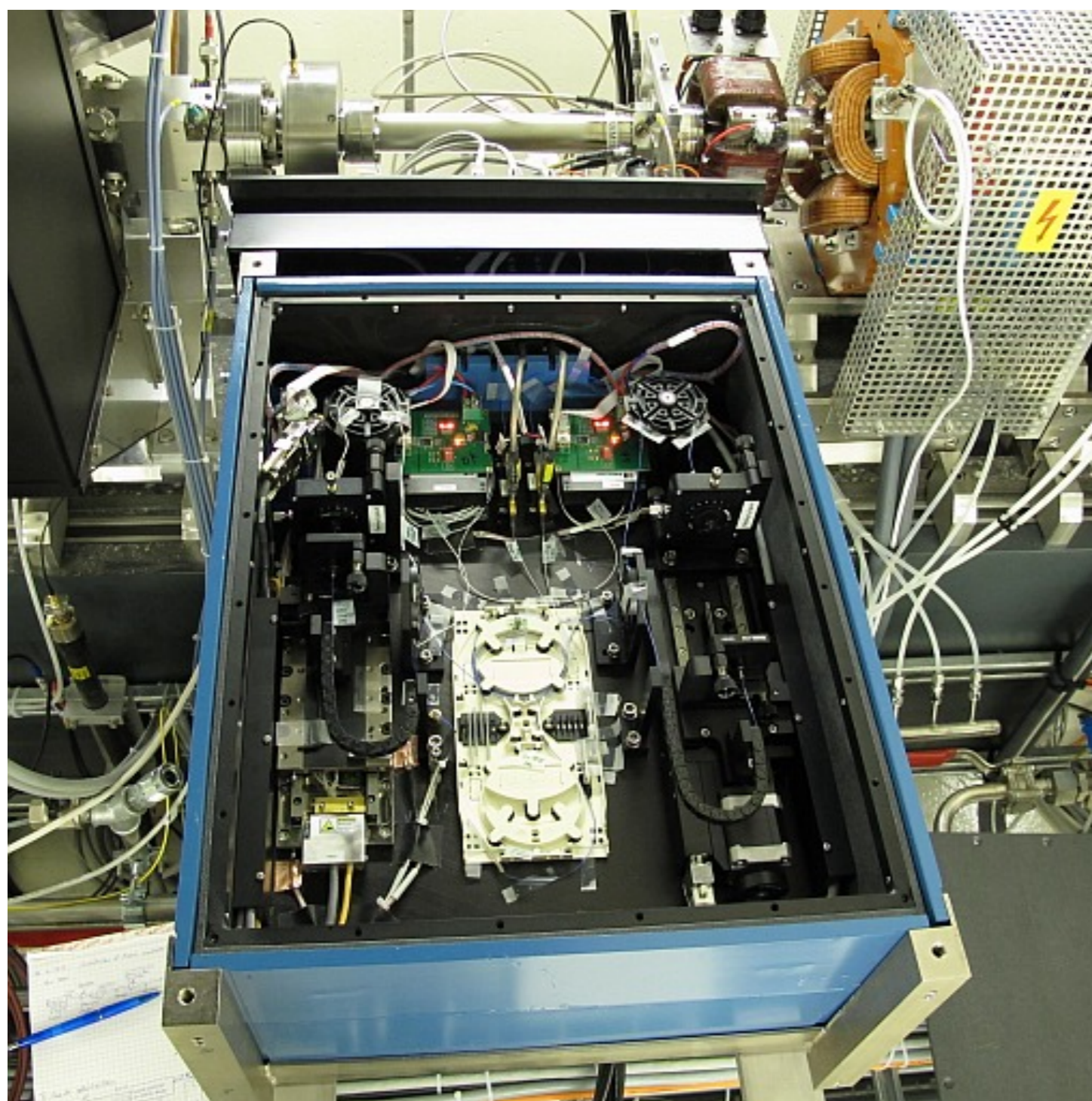
Button (38 mm chamber):

- 80 GHz design BW,
- Resolution limited by the feedthru, EOM and ADC. For 2 bunch operation needs an upgrade (ringing):
 - 200pc – 60 pc: 20 fs (measured)
 - 60 pC-10pC: 30fs -170 fs (measured)
- II. Ridge waveguide (RVWG) (38 mm chamber): insufficient resolution, non linear behavior, ringing

SITF BAM-Data Acquisition (GPAC ADC12FL)

- The ADC clock is generated by the laser pulses and is shifted simultaneously with them
- The laser pulse amplitude is normalized pulse-to-pulse
- The laser amplitude jitter is monitored online

BAM Front End Design in SITF (BOX Var. 1)



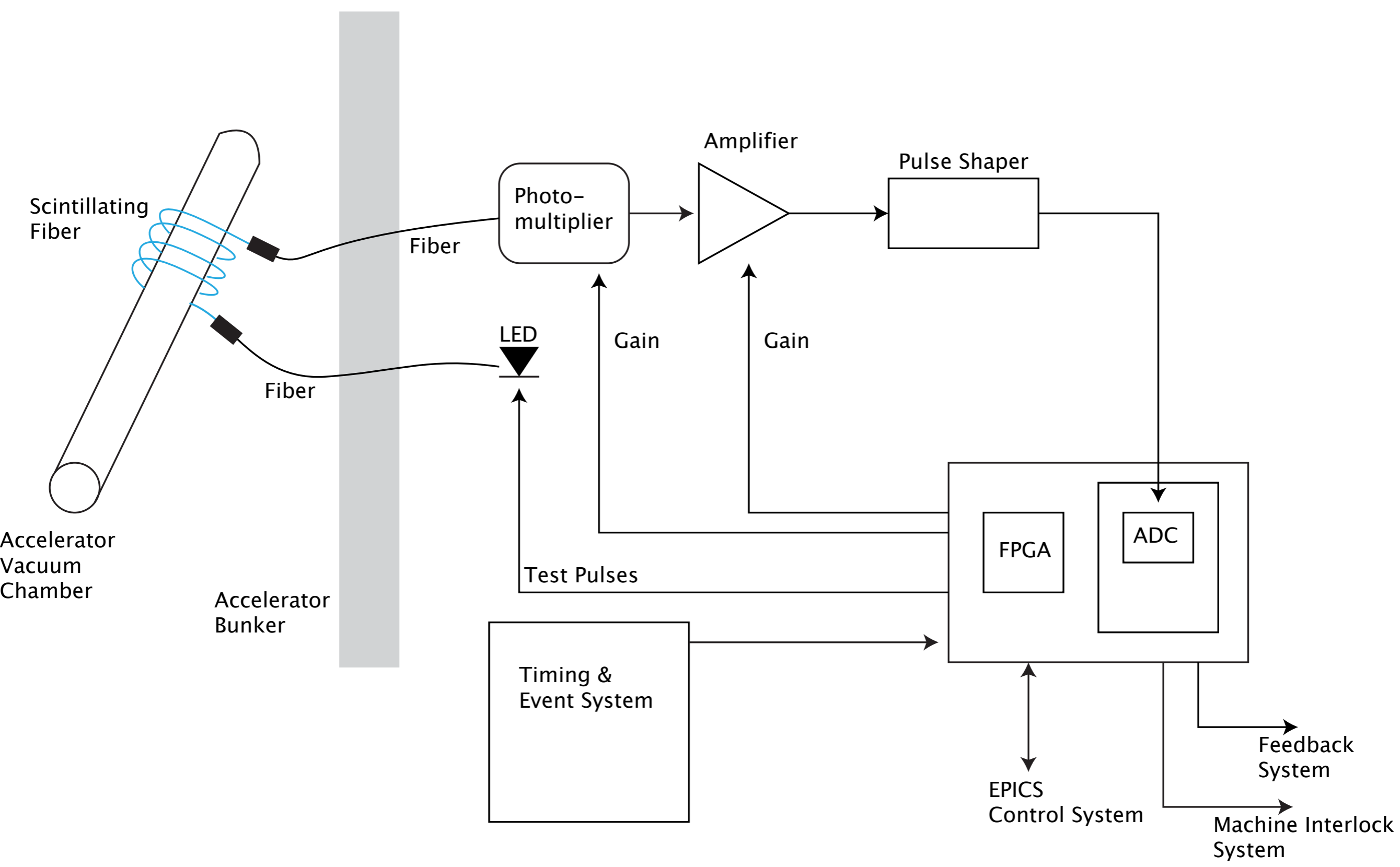
Dimensions (with the shielding):

640x450 mm (cables and cable radii not included)

Basic Components:

- EOMs (current status): 2x12 GHz (Covega) .
- EDFAs with controllers (custom design, Photop, CN)
- linear motor with 10 nm encoder (Parkem)
- linear motor controller
- stepper motor
- T° stabilization of the baseplate ($T_{pk-pk} < 0.05^{\circ}\text{C}$)
- T° & RH monitoring
- EPICs control, archiver channels
- EOM bias control and WP setting
- Radiation shielding (sufficient for SITF, insufficient for SwissFEL)
- possibility for channel extension (further EOMs)
- \exists Box Var. 2 with improved thermal management

Loss Monitor (DBLM)



Loss Monitor (DBLM)

- > Fiber-based system
 - > Compact, low installation costs
- > All electronics outside the accelerator tunnel
- > We need a large dynamic range
 - > Foresee to use vacuum PMTs
- > Digitization by fast ADC

